

Report No. MCR-22-0314 April 26,2022

# RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RX63T

DEVICE : R5F563TXXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



MCR-22-0314

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(Rev.5.0-2 October 2020)



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## Table. Reliability test results (QFP)

Test Items Reference Test Conditions		Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC) *1) With preconditioning per JESD	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

#### •Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 0.03 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term ( $\pi$ T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea : Activation energy (eV)
Ta : Ambient temperature ( $^{\circ}$ C)

$\pi$ T simplified chart as Ea=0.7 eV												
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

### ·MTTF ( Mean Time To Failure )

$$MTTF = 1/\lambda$$



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#### Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

<sup>\*1.</sup> First four digit

#### Table. Product list

	le. Product		_				
No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RX63T	R5F563TBADFA	PLQP0120K*	51	RX63T	R5F563TEBDFH	PLQP0112J*
2	RX63T	R5F563TBAGFA	PLQP0120K*	52	RX63T	R5F563TEBGFH	PLQP0112J*
3	RX63T	R5F563TBBDFA	PLQP0120K*	53	RX63T	R5F563TEDDFH	PLQP0112J*
1	RX63T	R5F563TBBGFA	PLQP0120K*	54	RX63T	R5F563TEEDFH	PLQP0112J*
5	RX63T	R5F563TBDDFA	PLQP0120K*	55	RX63T	R5F563T4EDFL	PLQP0048K*
5	RX63T	R5F563TBEDFA	PLQP0120K*	56	RX63T	R5F563T4EGFL	PLQP0048K*
7	RX63T	R5F563TCADFA	PLQP0120K*	57	RX63T	R5F563T5EDFL	PLQP0048K*
3	RX63T	R5F563TCAGFA	PLQP0120K*	58	RX63T	R5F563T5EGFL	PLQP0048K*
)	RX63T	R5F563TCBDFA	PLQP0120K*	59	RX63T	R5F563T6EDFL	PLQP0048K*
LO	RX63T	R5F563TCBGFA	PLQP0120K*	60	RX63T	R5F563T6EGFL	PLQP0048K*
L1	RX63T	R5F563TCDDFA	PLQP0120K*	61	RX63T	R5F563T4EDFM	PLQP0064K*
.2	RX63T	R5F563TCEDFA	PLQP0120K*	62	RX63T	R5F563T4EGFM	PLQP0064K*
L3	RX63T	R5F563TEADFA	PLQP0120K*	63	RX63T	R5F563T5EDFM	PLQP0064K*
L4	RX63T	R5F563TEAGFA	PLQP0120K*	64	RX63T	R5F563T5EGFM	PLQP0064K*
L5	RX63T	R5F563TEBDFA	PLQP0120K*	65	RX63T	R5F563T6EDFM	PLQP0064K*
.6	RX63T	R5F563TEBGFA	PLQP0120K*	66	RX63T	R5F563T6EGFM	PLQP0064K*
17	RX63T	R5F563TEDDFA	PLQP0120K*	67	RX63T	R5F563TBADFP	PLQP0100K*
18	RX63T	R5F563TEEDFA	PLQP0120K*	68	RX63T	R5F563TBAGFP	PLQP0100K*
19	RX63T	R5F563TBADFB	PLQP0144K*	69	RX63T	R5F563TBBDFP	PLQP0100K*
20	RX63T	R5F563TBAGFB	PLQP0144K*	70	RX63T	R5F563TBBGFP	PLQP0100K*
21	RX63T	R5F563TBBDFB	PLQP0144K*	71	RX63T	R5F563TBDDFP	PLQP0100K*
22	RX63T	R5F563TBBGFB	PLQP0144K*	72	RX63T	R5F563TBEDFP	PLQP0100K*
23	RX63T	R5F563TBDDFB	PLQP0144K*	73	RX63T	R5F563TCADFP	PLQP0100K*
24	RX63T	R5F563TBEDFB	PLQP0144K*	74	RX63T	R5F563TCAGFP	PLQP0100K*
25	RX63T	R5F563TCADFB	PLQP0144K*	75	RX63T	R5F563TCBDFP	PLQP0100K*
26	RX63T	R5F563TCAGFB	PLQP0144K*	76	RX63T	R5F563TCBGFP	PLQP0100K*
<u>2</u> 7	RX63T	R5F563TCBDFB	PLQP0144K*	77	RX63T	R5F563TCDDFP	PLQP0100K*
28	RX63T	R5F563TCBGFB	PLQP0144K*	78	RX63T	R5F563TCEDFP	PLQP0100K*
29	RX63T	R5F563TCDDFB	PLQP0144K*	79	RX63T	R5F563TEADFP	PLQP0100K*
30	RX63T	R5F563TCEDFB	PLQP0144K*	80	RX63T	R5F563TEAGFP	PLQP0100K*
31	RX63T	R5F563TEADFB	PLQP0144K*	81	RX63T	R5F563TEBDFP	PLQP0100K*
32	RX63T	R5F563TEAGFB	PLQP0144K*	82	RX63T	R5F563TEBGFP	PLQP0100K*
33	RX63T	R5F563TEBDFB	PLQP0144K*	83	RX63T	R5F563TEDDFP	PLQP0100K*
34	RX63T	R5F563TEBGFB	PLQP0144K*	84	RX63T	R5F563TEEDFP	PLQP0100K*
35	RX63T	R5F563TEDDFB	PLQP0144K*	85	10001	KSI SOSTEEDIT	I LQI OTOOK
36	RX63T	R5F563TEEDFB	PLQP0144K*	86			
87	RX63T	R5F563TBADFH	PLQP0144X*	87			
38	RX63T	R5F563TBAGFH	PLQP0112J*	88			
39	RX63T	R5F563TBBDFH	PLQP0112J*	89			
10	RX63T	R5F563TBBGFH	PLQP0112J*	90			
1	RX63T	R5F563TBDDFH	PLQP0112J*	90			
12	RX63T	R5F563TBEDFH	PLQP0112J*	91	+		
13	RX63T	R5F563TCADFH	PLQP0112J*	93			+
			PLQP0112J*				
14	RX63T	R5F563TCAGFH		94			
15	RX63T	R5F563TCBDFH	PLQP0112J*	95			
16	RX63T	R5F563TCBGFH	PLQP0112J*	96			
17	RX63T	R5F563TCDDFH	PLQP0112J*	97			
18	RX63T	R5F563TCEDFH	PLQP0112J*	98	+		1
19	RX63T	R5F563TEADFH	PLQP0112J*	99			
50	RX63T	R5F563TEAGFH	PLQP0112J*	100	1		